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Data Sheet

LED Chip blue-green

EOLC-505-34

Rev. 03, 2017

Radiation	Type	Electrodes
blue-green	GaN / sapphire	P + N up

	Description - Substrate: sapphire, epitaxial layer: GaN based material - N bonding pad electrode: Au alloy - P bonding pad electrode: Au alloy
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Maximum Ratings

T_{amb} = 25°C, unless otherwise specified

Parameter	Test cond.	Symbol	Min	Typ	Max	Unit
Forward current (DC)		I _F			20	mA
Peak forward current	t _p ≤ 50 μs, t _p /T = 1/2	I _{FM}			100	mA

Optical and Electrical Characteristics

T_{amb} = 25°C, unless otherwise specified

Parameter	Test cond.	Symbol	Min	Typ	Max	Unit
Forward voltage	I _F = 20 mA	V _F		3.3	3.5	V
Reverse current	V _R = 5 V	I _R			1	μA
Luminous intensity*	I _F = 20 mA	I _v	300	400	500	mcd
Luminous flux*	I _F = 20 mA	Φ _v		1700		mlm
Radiant intensity*	I _F = 20 mA	I _e		1.1		mW/sr
Radiant power*	I _F = 20 mA	Φ _e		7.4		mW
Peak wavelength	I _F = 20 mA	λ _p		502		nm
Dominant wavelength	I _F = 20 mA	λ _D	502	505	508	nm
FWHM	I _F = 20 mA	Δλ _{0.5}		30		nm

*Measured on bare chip on TO-18 header

Packing: Chips on adhesive film with wire-bond side top

Art. No. 112 030



We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer.